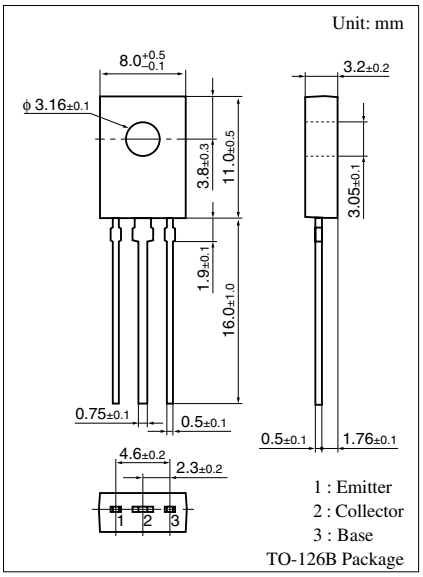
2SC1568

Silicon NPN epitaxial planar type

For low-voltage type medium output power amplification
Complementary to 2SA0900 (2SA900)



■ Features

- Low collector to emitter saturation voltage $V_{CE(sat)}$
- Satisfactory operation performances and high efficiency with a low-voltage power supply
- TO-126B package which incorporates a unique construction enabling installation to the heat sink without using insulation parts

■ Absolute Maximum Ratings $T_C = 25°C$

Parameter	Symbol	Rating	Unit
Collector to base voltage	V_{CBO}	18	V
Collector to emitter voltage	V_{CEO}	18	V
Emitter to base voltage	V_{EBO}	5	V
Peak collector current	I_{CP}	2	A
Collector current	I_C	1	A
Collector power dissipation *	P_C	1.2	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	−55 to +150	°C

Note) *: Without heat sink

■ Electrical Characteristics $T_C = 25°C$

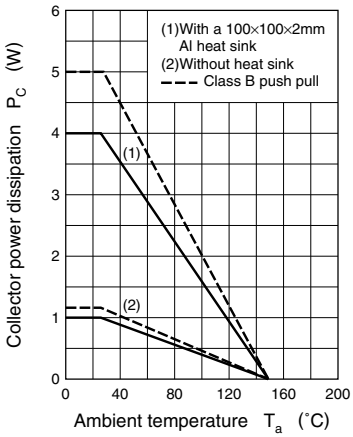
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector cutoff current	I_{CBO}	V_{CB} = 10 V, I_E = 0			1	μA
	I_{CEO}	V_{CE} = 18 V, I_B = 0			10	μA
Collector to base voltage	V_{CBO}	I_C = 10 μA, I_E = 0	18			V
Collector to emitter voltage	V_{CEO}	I_C = 1 mA, I_B = 0	18			V
Emitter to base voltage	V_{EBO}	I_E = 10 μA, I_C = 0	5			V
Forward current transfer ratio	h_{FE1} *	V_{CE} = 2 V, I_C = 500 mA	90		280	
	h_{FE2}	V_{CE} = 2 V, I_C = 1.5 A	50	100		
Collector to emitter saturation voltage	$V_{CE(sat)}$	I_C = 1 A, I_B = 50 mA			0.5	V
Base to emitter saturation voltage	$V_{BE(sat)}$	I_C = 500 mA, I_B = 50 mA			1.2	V
Transition frequency	f_T	V_{CB} = 6 V, I_E = −50 mA, f = 200 MHz		150		MHz
Collector output capacitance	C_{ob}	V_{CB} = 6 V, I_E = 0, f = 1 MHz		12		pF

Note) *: Rank classification

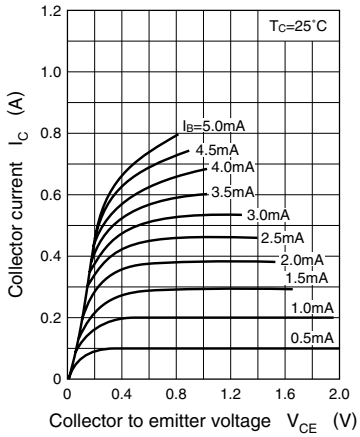
Rank	Q	R	S
h_{FE1}	90 to 155	130 to 210	180 to 280

Note) The part number in the parenthesis shows conventional part number.

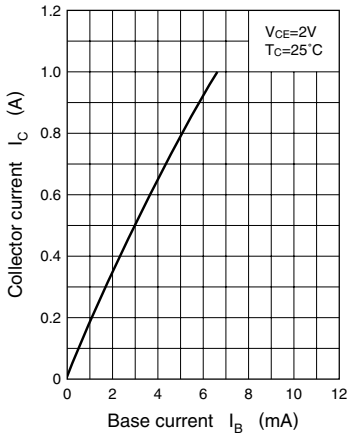
P_C — T_a



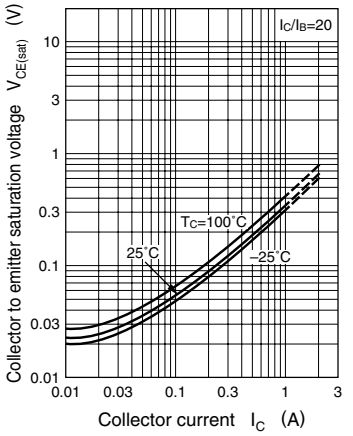
I_C — V_{CE}



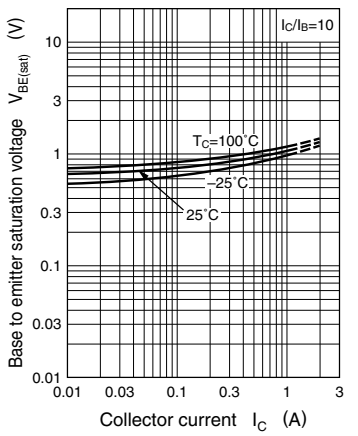
I_C — I_B



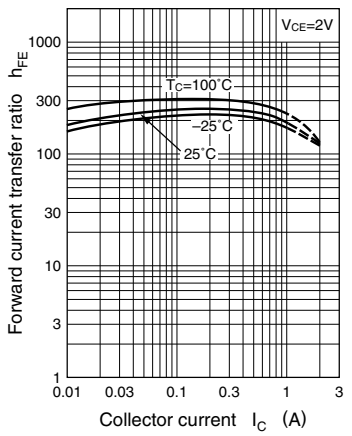
$V_{CE(sat)}$ — I_C



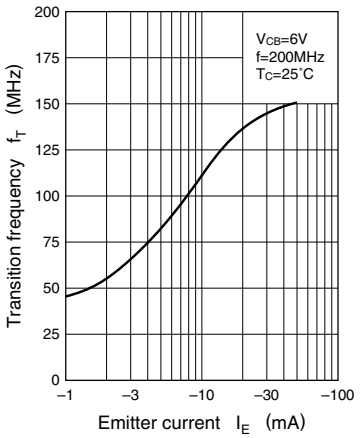
$V_{BE(sat)}$ — I_C



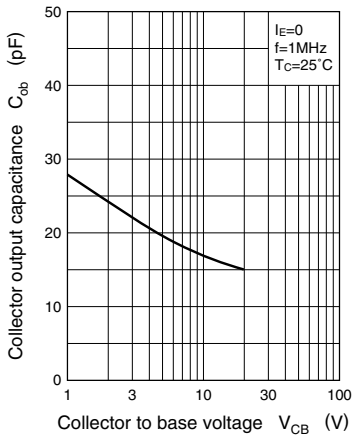
h_{FE} — I_C



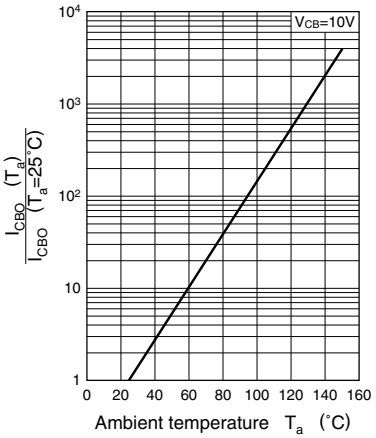
f_T — I_E



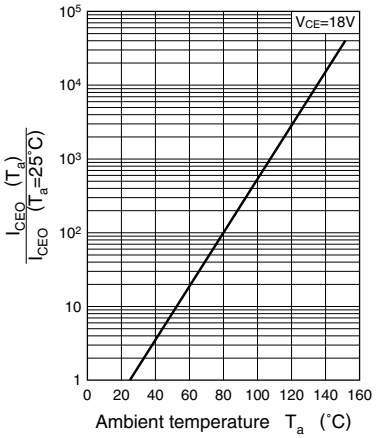
C_{ob} — V_{CB}



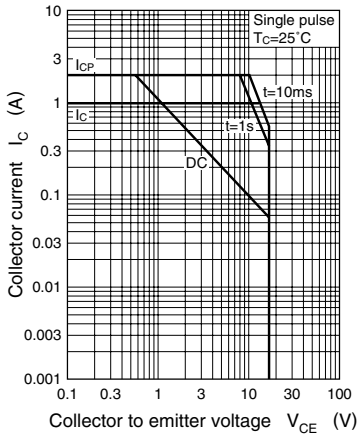
I_{CBO} — T_a



I_{CEO} — T_a



Area of safe operation (ASO)



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